

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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| In re Patent Application of: |) | |
| |) | |
| Ashay A. Dani, et al. |) | |
| |) | Examiner: Sheeba Ahmed |
| Application No.: 10/038,334 |) | |
| |) | Art Unit: 1773 |
| Filed: October 18, 2001 |) | |
| |) | |
| For: THERMAL INTERFACE MATERIAL |) | |
| AND ELECTRONIC ASSEMBLY |) | |
| HAVING SUCH A THERMAL |) | |
| INTERFACE MATERIAL |) | |
| _____ |) | |

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE TO OFFICE ACTION

Dear Sir:

In response to the Office Action dated February 1, 2006, Applicant respectfully requests that the above-identified application be amended as follows and that the following remarks be considered: